**IRF710** 

Vishay Siliconix



**TO-220AB** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>a</sub> max. (nC)

Configuration

# **Power MOSFET**

S

N-Channel MOSFET

3.6

400

17

3.4

8.5

Single

V<sub>GS</sub> = 10 V

### FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF710PbF		
Lead (Pb)-free and halogen-free	IRF710PbF-BE3		

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	400	V	
Gate-source voltage			V <sub>GS</sub>	± 20	v	
Continuous drain current	$V_{GS} \text{ at } 10 \text{ V} \qquad T_{C} = 25^{\circ}$ $T_{C} = 100^{\circ}$	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	2.0		
		T <sub>C</sub> = 100 °C		1.2	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	6.0		
Linear derating factor				0.29	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	120	mJ	
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	2.0	A	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	3.6	mJ	
Maximum power dissipation	T <sub>C</sub> =	25 °C	PD	36	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	4.0	V/ns	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	*0		
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300	°C	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 52 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 2.0$  A (see fig. 12)

c.  $I_{SD} \le 2.0$  A, dl/dt  $\le 40$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	3.5	

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		400	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, $I_D = 1 \text{ mA}$		0.47	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	4.0	V
Gate-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20 V$		-	± 100	nA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	25	μA
		V <sub>DS</sub> = 320V	V <sub>DS</sub> = 320V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	250	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1.2 A <sup>b</sup>	-	-	3.6	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	50 V, I <sub>D</sub> = 1.2 A <sup>b</sup>	1.0	-	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$		-	170	-	pF
Output capacitance	C <sub>oss</sub>		$V_{DS} = 25 V$ ,		34	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	6.3	-	
Total gate charge	Qg		V <sub>GS</sub> = 10 V I <sub>D</sub> = 2.0 A, V <sub>DS</sub> = 320 V see fig. 6 and 13 <sup>b</sup>	-	-	17	nC
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$		-	-	3.4	
Gate-drain charge	Q <sub>gd</sub>			-	-	8.5	1
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD} = 200 \text{ V, } I_D = 2.0 \text{ A,} \\ R_g = 24 \Omega, R_D = 95 \Omega \\ \text{see fig. 10 }^{\text{b}}$		-	8.0	-	ns
Rise time	t <sub>r</sub>			-	9.9	-	
Turn-off delay time	t <sub>d(off)</sub>			-	21	-	
Fall time	t <sub>f</sub>			-	11	-	
Gate input resistance	Rg	f = 1 MHz, open drain		1.7	-	11.2	Ω
Internal drain inductance	L <sub>D</sub>	6 mm (0.25	Between lead, 6 mm (0.25") from		4.5	-	الم
Internal source inductance	L <sub>S</sub>	package and center of die contact		-	7.5	-	nH
Drain-Source Body Diode Characteristic	s					•	•
Continuous source-drain diode current	I <sub>S</sub>	showing	MOSFET symbol showing the		-	2.0	^
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	p - n junction diode		-	-	6.0	A
Body diode voltage	V <sub>SD</sub>	$T_J = 25 \ ^{\circ}C, I_S = 2.0 \ A, V_{GS} = 0 \ V^{b}$		-	-	1.6	V
Body diode reverse recovery time	t <sub>rr</sub>	T.1 =			240	540	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 2.0 A, dl/dt = 100 A/μs <sup>b</sup>		-	0.85	1.6	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$					

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

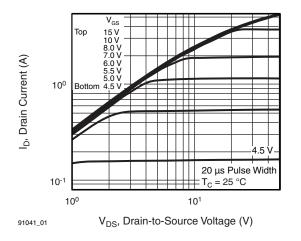


Fig. 1 - Typical Output Characteristics,  $T_C = 25 \ ^{\circ}C$ 

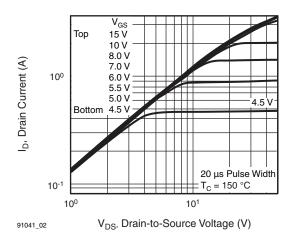
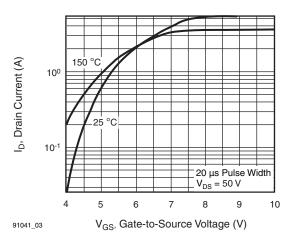


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150  $^\circ C$ 





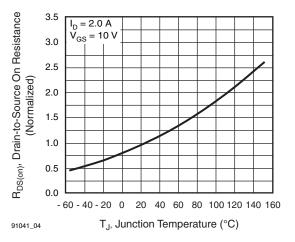


Fig. 4 - Normalized On-Resistance vs. Temperature

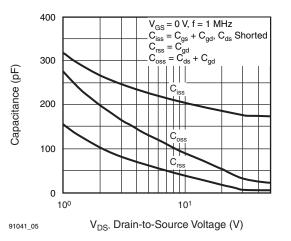
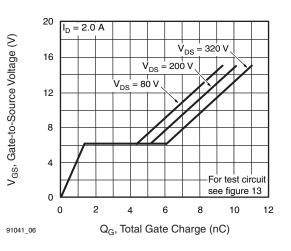


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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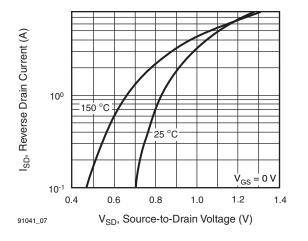


Fig. 7 - Typical Source-Drain Diode Forward Voltage

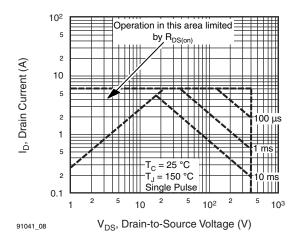


Fig. 8 - Maximum Safe Operating Area

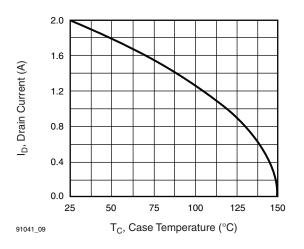


Fig. 9 - Maximum Drain Current vs. Case Temperature

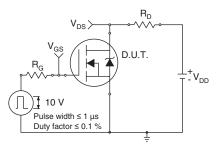


Fig. 10a - Switching Time Test Circuit

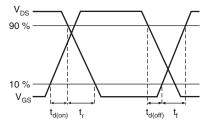


Fig. 10b - Switching Time Waveforms

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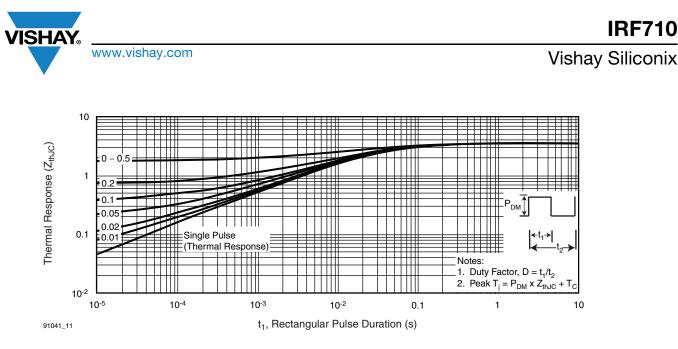


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

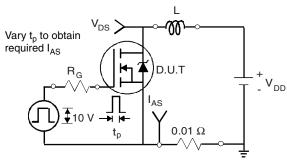
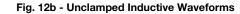


Fig. 12a - Unclamped Inductive Test Circuit

V<sub>DD</sub>

'DS



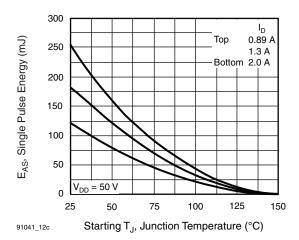


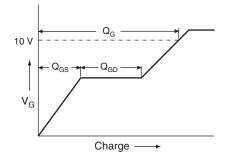
Fig. 12c - Maximum Avalanche Energy vs. Drain Current

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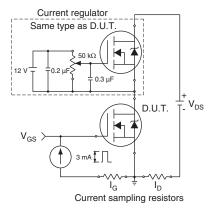
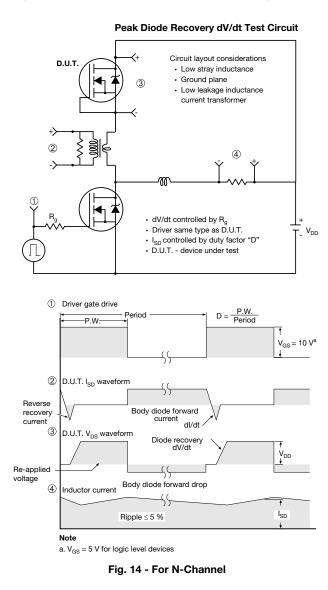


Fig. 13a - Basic Gate Charge Waveform





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